

2SK3527-01

**FUJI POWER MOSFET**  
**Super FAP-G Series**
**N-CHANNEL SILICON POWER MOSFET**
**■ Features**

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

**■ Applications**

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

**■ Maximum ratings and characteristic**
**(Tc=25°C unless otherwise specified)**

Item	Symbol	Ratings	Unit
Drain-source voltage	VDS	600	V
	VDSX *5	600	V
Continuous drain current	Id	±17	A
Pulsed drain current	Id(puls)	±68	A
Gate-source voltage	VGS	±30	V
Repetitive or non-repetitive	IAR *2	17	A
Maximum Avalanche Energy	EAS *1	412	mJ
Maximum Drain-Source dV/dt	dVds/dt *4	20	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	Pd	2.50	W
	Ta=25°C		
	Tc=25°C	220	
Operating and storage temperature range	Tch	+150	°C
	Tstg	-55 to +150	°C

\*1 L=2.62mH, Vcc=60V   \*2 Tch≤150°C   \*3 If≤ -Id, -di/dt=50A/μs, Vcc≤BVdss, Tch≤150°C

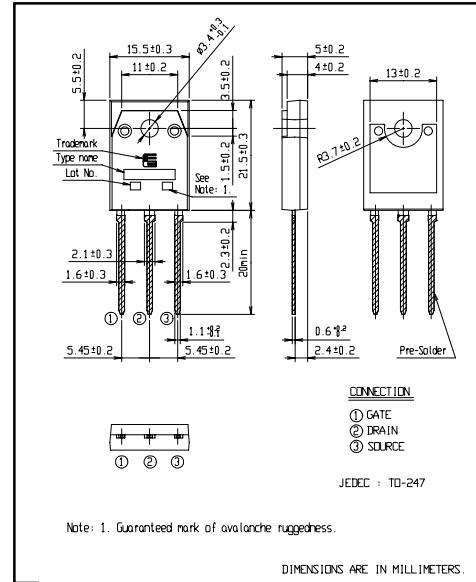
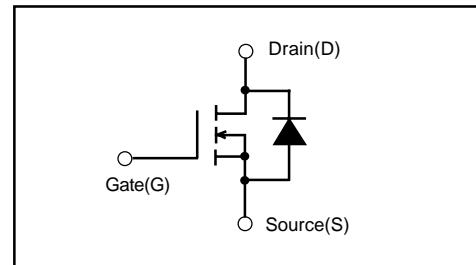
\*4 VDS≤ 600V   \*5 Vgs=-30V

**● Electrical characteristics (Tc =25°C unless otherwise specified)**

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id= 250μA VGS=0V	600			V
Gate threshold voltage	VGS(th)	Id= 250μA VDS=VGS	3.0		5.0	V
Zero gate voltage drain current	Idss	VDS=600V VGS=0V		25		μA
		VDS=480V VGS=0V		250		
Gate-source leakage current	IGSS	VGS=±30V VDS=0V		10	100	nA
Drain-source on-state resistance	RDS(on)	Id=8.5A VGS=10V		0.29	0.37	Ω
Forward transconductance	gfs	Id=8.5A VDS=25V	10	20		S
Input capacitance	Ciss	VDS=25V		2280	3420	pF
Output capacitance	Coss	VGS=0V		290	435	
Reverse transfer capacitance	Crss	f=1MHz		16	24	
Turn-on time ton	td(on)	Vcc=300V Id=8.5A		26	39	ns
	tr	VGS=10V		37	56	
Turn-off time toff	td(off)	Rgs=10 Ω		78	117	
	tf			13	19	
Total Gate Charge	QG	Vcc=300V		54	81	nC
Gate-Source Charge	QGS	Id=17A		15	23	
Gate-Drain Charge	QGD	VGS=10V		20	30	
Avalanche capability	IAV	L=2.62mH Tch=25°C	17			A
Diode forward on-voltage	VSD	If=17A VGS=0V Tch=25°C		0.93	1.50	V
Reverse recovery time	trr	If=17A VGS=0V		0.7		μs
Reverse recovery charge	Qrr	-di/dt=100A/μs Tch=25°C		10.0		μC

**● Thermal characteristics**

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			0.568	°C/W
	Rth(ch-a)	channel to ambient			50.0	°C/W

**■ Outline Drawings**

**■ Equivalent circuit schematic**


## ■ Characteristics

